Investigations on electro-optical and thermal performances degradation of high power density GaAs-based laser diode in vacuum environment

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Pump laser diodes emitting at 980 nm are typically used in distribution network transmission systems and are now implemented in space missions for intra-satellite communication links and calibration systems. Nevertheless, since the pump source is potentially a critical point for such systems, there is a huge need to assess their reliability in space environment, especially in terms of operation under vacuum conditions. We have then studied the electro-optical behavior of several 980 nm laser diodes and shown that they may degrade more rapidly when submitted to a vacuum environment. Then, spatially resolved temperature variations have been measured by thermoreflectance on the laser diode front facet and have shown a temperature variation increase under vacuum conditions, in particular near the emission region, where a catastrophic optical damage is most likely to occur. This temperature variation increase could then be one of the causes for the more rapid laser diode degradation.

1. Context and motivation

High power density GaAs-based pump laser diodes emitting at 980 nm are typically used in optical network transmission systems in Erbium-Doped Fiber Amplifiers [1] for long distance and large capacity optical telecommunication systems. Such devices are also used in space missions for Fiber Optic Gyroscopes, and intra-satellite communication links [2]. However as the pump diode is potentially a critical point for such systems, there is a huge need to assess their reliability in space environment, especially in terms of operation under vacuum conditions.

Some published studies [3,4] have already been reported on qualification testing of high power 808 nm pump laser diodes arrays in vacuum environment. No catastrophic failures were observed and the authors concluded that the laser diodes are robust enough to survive in the harsh space environment. However up to now, long term in-vacuum reliability testing of 980 nm laser diodes was never clearly addressed. Because the chip is embedded into a sealed package, it is not directly exposed to vacuum environment but depending on the package leak rate, the internal pressure may vary from its initial value to the external pressure one.

The study presented here takes part of a full evaluation program managed by the French Space Agency (CNES) with a specific focus on long-term CW aging of 980 nm laser modules under vacuum. The chip is a spatially single mode 980 nm laser diode housed in a hermetically sealed butterfly package with dual-lens coupling optics. Eight packaged diodes were studied and among them, four were specifically punctured before the aging test to accelerate the out-diffusion of gaseous contents and to simulate the behavior of the laser diode after a long high vacuum exposition at 10−7 mbar. After the test, the non-punctured components are fully operational whereas three out of four modules, of the punctured group, suddenly failed.

In a previous paper [5], we investigated the main mechanism originating from the failure. For that, ToF-SIMS measurements revealed no significant evidence of organic contamination in relation with the packaging puncturing. This allows us to discard a Particle Induced Failure (PIF) hypothesis and assume that the vacuum test system or the laser diode package itself is unlikely to be at the origin of the failure. Dark lines were identified inside the bulk using cathodoluminescence (CL) measurements corresponding to local non-radiative recombination centers. Specific FIB prepared samples were analyzed by TEM and revealed a quantum well melting/re-solidification. The increase of temperature due to zero-convection in vacuum may be the probable root cause of degradation. We must point out that these failures occurred only on punctured devices and were not observed on hermetic devices. With this past study, we concluded that dual-lens optical alignment type, as included in such laser modules, featuring a measured leak rate close to 10−10 atm·cm−2/s are able to withstand reliable operation in high
Suspecting a catastrophic optical damage (COD) due to a laser diode front facet temperature increase, presumably due to the lack of convection effect, in this paper, we particularly investigate the thermal behavior of these devices in air and under vacuum. Temperature variations of unpackaged laser diodes are then estimated on different positions of the front facet using a spatially resolved thermoreflectance technique.

2. Device technology and electro-optical characterization

2.1. Device technology

The active devices under test consist in single AlGaAs/InGaAs quantum well laser diodes emitting at 980 nm inside a hermetically sealed butterfly package with dual-lens optics. Fig. 1 gives a basic cross-section scheme of the device front facet. The 3.9 mm long ridge structure, covered by a gold layer, allows us to confine the current and the light emission in the quantum well of the active region at the p–n junction, thus reducing the threshold current. Operating under a monomode spectrum, the module includes a wavelength locking process based on a Fiber Bragg Grating inscribed in a Polarization Maintaining Fiber, providing an excellent stability and very wide dynamic range.

Such modules also contain a back-facet photodiode for monitoring purposes and a getter. The reference operating conditions are 40 °C for a 500 mA nominal current, leading to a 300 mW optical power.

2.2. Electro-optical characterization

The electro-optical characterizations were performed on eight modules in a vacuum chamber. They consisted in optical power, monitoring photodiode current and voltage versus driving current measurements (L-Q-V-I), spectrum measurements and low-level current versus voltage characteristics (I-V). Fig. 2 shows typical initial (i.e., before aging) L-Q-V-I characteristics in air and vacuum (10⁻⁷ mbar) of a laser diode at 25 °C. One can notice that these curves are typical for a 980 nm pump laser diode and no basic kink effect is observable [6,7]. Then, their optical spectrum in air and vacuum at 25 °C and 500 mA was measured. Both spectra are very similar and the power-in-band is greater than 99.9% which suggests that the Bragg grating peak wavelength is correctly locked with the emission spectrum of the laser chip.

The aging tests were performed at 60 °C and 800 mA during almost 5000 h under a 10⁻⁷ mbar pressure. Among the eight modules, LD1 to LD4 were kept sealed and LD5 to LD8 were punctured. The tracking of the optical power variation of the eight laser diodes in vacuum is shown in Fig. 3. Three punctured components (LD5, LD6 and LD7) suddenly failed before the end of the planned aging period. The optical power and photodiode current dramatically dropped whereas the laser voltage slightly increased after 1037 h of operation for LD5, 1934 h for LD6 and 2227 h for LD8. The degradation is sudden instead of gradual suggesting a COD phenomenon. No sealed component failed during the aging. It clearly demonstrates the influence of high level vacuum testing and the fastest catastrophic drop of the optical power in comparison of aging tests in air using the same conditions (>5000 h). Since the key parameter leading to a COD may be a front facet temperature increase, a non-contact and non-invasive technique offering submicrometric spatial resolution capabilities, namely optical thermoreflectance, was applied on unpackaged 980 nm laser diodes to accurately characterize the thermal behavior on the front facet both in air and in vacuum.

3. Thermal characterization

3.1. Thermoreflectance experimental set-up

To evaluate the temperature variations to which the functioning laser diode is submitted, we use a classical thermoreflectance set-up [8]: when the surface of a device or material is submitted to a temperature variation ΔT, it induces a relative reflectivity variation ΔR/R proportional to ΔT. Then, probing the surface with a laser beam, the relative intensity variation of the reflected beam can be measured and ΔR/R is extracted. Among thermal mapping methods, thermoreflectance is an accurate, non-contact and non-invasive method. Its spatial resolution is limited by diffraction and depends on the probe wavelength and on the optical equipment used. Under visible illumination, it is classically micrometric but can reach a few hundred nanometers with a high numerical aperture objective. In our case, the diode is biased using a ITCS10 current source, allowing to adjust the operating point, connected with a 33250 A voltage generator to modulate the driving current

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which is a 50% duty cycle square current ($f = 442$ Hz) varying from 0.1 mA to $I_{\text{max}}$. $I_{\text{max}}$ can be adjusted from 6 mA to 1 A. Then, the electrical power is mainly dissipated at frequency $f$, which induces a temperature variation at the same frequency $\Delta T_f$, and consequently a reflectivity variation $\Delta R_f$. The relative reflectivity variation is related to $\Delta T_f$ according to Eq. (1):

$$\frac{\Delta R_f}{R} = \frac{1}{R} \frac{\partial R}{\partial T} \Delta T_f = \kappa \times \Delta T_f$$

where $R$ is the sample mean reflectivity and $\kappa$ is the thermoreflectance coefficient mainly depending on the nature of the material and on the probe beam wavelength. Subsequently, $\Delta R/R$ and $\Delta T_f$ are simply noted $\Delta R/R$ and $\Delta T_f$, respectively.

A schematic of the thermoreflectance set-up is presented in Fig. 4. A probe laser beam (He-Ne) at $\lambda = 632$ nm, for which the thermoreflectance coefficient $\kappa$ has been measured to be maximum, is focused by a $\times 20$ magnification and 0.3 numerical aperture microscope objective on the front facet of the unpackaged laser diode and then reflected at its surface. Then, the relative intensity variation $\Delta I/I$ of the reflected probe, which directly gives $\Delta R/R$, is measured by a photodiode. The spot diameter, which limits the spatial resolution, was evaluated to 3 μm approximately and the $\Delta R/R$ set-up sensitivity was measured to be as low as $2 \times 10^{-6}$. To operate under vacuum, we added to the detailed set-up described in [9] a vacuum chamber where the laser diode under test is positioned. This chamber can work down to $10^{-6}$ mbar. When the device is positioned in the chamber, its pressure is stabilized around $3 \times 10^{-4}$ mbar, and the measurements under vacuum presented subsequently are performed at this pressure value. In addition, the vacuum chamber is equipped with a micrometric translation stage to displace the laser diode under test.

First, the thermoreflectance signal is measured as a function of the bias current, $I_{\text{max}}$ varying from 6 mA to 1 A with a 3 mA step when the probe beam is focused at $y = 10$ μm on the $y$ axis. This measurement was done for 4 different pressure levels: atmospheric pressure, $7 \times 10^{-4}$ mbar, $3 \times 10^{-4}$ mbar and $3 \times 10^{-5}$ mbar as plotted in Fig. 5. When the pressure level decreases, we clearly note an increase of the thermoreflectance signal, thus of the temperature variation, up to 20%. A pressure influence is then obvious. Subsequently, all the “vacuum” measurements are done under a $3.2 \times 10^{-4}$ mbar pressure.

3.3. Temperature variation measurements

All the measurements presented below are done on 3 laser diodes and repeated three times. The curves correspond to the calculated mean values.

3.3.1. Influence of the bias current on the thermoreflectance signal

We first focused on two positions $M_1$ and $M_2$, respectively about 5 μm and 60 μm away from the emitting source on the $y$ axis (see Fig. 1). Then the thermoreflectance signal is monitored as a function of the bias current $I_{\text{max}}$ varying from 6 mA to 1 A with a 3 mA step (see Fig. 6). Table 1 summarizes the main results obtained under atmospheric conditions and under vacuum. We note that the mean thermoreflectance signal between the threshold current and $I = 1$ A increases under vacuum by 6.7% and 13.8% at positions $M_1$ and $M_2$, respectively, but the increase can, respectively, reach 8.9% and 15.6% at maximum current $I = 1$ A.

Even if the increase is higher at position $M_2$, it is less critical than for position $M_1$, for which the absolute thermoreflectance signal, therefore the absolute temperature variation, is higher.

$$\begin{align*}
\Delta R/R (I = 0.3 \text{ A}) & \quad \Delta R/R (I = 1 \text{ A}) & \quad \Delta R/R \text{ increase ratio (I = 1 A)} \\
(\times 10^{-4}) & \quad (\times 10^{-4}) & \quad (%) \\
M_1 (\text{air}) & \quad 4.3 & \quad 12.3 \\
M_1 (\text{vac}) & \quad 4.63 & \quad 13.4 & \quad 8.9 & \quad 6.7 \\
M_2 (\text{air}) & \quad 0.73 & \quad 2.90 \\
M_2 (\text{vac}) & \quad 0.82 & \quad 3.35 & \quad 15.6 & \quad 13.8 \\
\end{align*}$$

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3.3.2. Thermoreflectance signal scans

The objective of this work is also to assess, as accurately as possible, the temperature distribution at the output facet. For that, the relative reflectivity variation is measured along the vertical axis $y$ when $I_{\text{max}} = 800$ mA (see Fig. 7). The first point ($y = 2 \text{ m}u$) corresponds to the bottom of the emitting source towards the AlN heat sink. The displacement step is $3 \text{ m}u$ for the first step and then $5 \text{ m}u$ between $y = 5$ and $80 \text{ m}u$. We clearly see that the thermoreflectance signal, hence the temperature variation, is higher under vacuum than in air. The signal increase reaches a mean value of almost 10% along the whole scan and reaches 31% in the close vicinity of the emitting source between $y = 2 \text{ m}u$ and $y = 10 \text{ m}u$. We also measured (see Fig. 8) the thermoreflectance signal on a horizontal scan, along the black horizontal full line (see Fig. 1), for $y = 2 \text{ m}u$ and between $x = -25 \text{ m}u$ and $x = 25 \text{ m}u$ with a 5 m step. Here again, we noted a thermoreflectance signal increase, when measuring under vacuum, reaching 27% near the emitting zone (around $x = 0$) and a mean value of 14% between $x = -10 \text{ m}u$ and $x = 10 \text{ m}u$.

4. Conclusion

Electro-optical measurements have shown that laser diode modules submitted to vacuum conditions seemed to undergo a COD more rapidly than in air. Thermoreflectance measurements have confirmed that the temperature variations of the front facet are higher under vacuum, with an increase reaching around 30% close to the active region, which could constitute one of the possible causes for an early degradation of the laser diodes. Further investigations must be conducted to study other possible causes of failure.

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References